

PRODUCT SPECIFICATIONS

Front View

Box-PC Barebone BPCWL02-i3 Intel Core i3-8145UE Processor

FANLESS SHUTTLE BOX-PC

WITH INTEL CORE ULV PROCESSOR IN A ROBUST CHASSIS Shuttle's new generation BPCWL02 IPC Series in a ruggedized box design for high durability consists of compact fanless IPC systems with modular expansion for wide-range industrial applications.



- Dimensions (LWH): 16.9 x 24.5 x 5.7 cm (2.7 L) Net weight: 2.85 kg
- IP Rating: IP30 Mounting options: VESA, Ear mount and DIN Rail

OPERATING TEMPERATURE RANGE [1]

- Standard: 0 +40 °C Industry: -20 +60 °C (Optional)
- Operating humidity: 20 ~ 80% (non-condensing)

OPERATING SYSTEM SUPPORT

- An operating system is not included.
- Supports Windows 10/11 and Linux (64-bit)

PROCESSOR

■ intel Core i3-8145UE Gen. 8 "Whiskey Lake" ULV processor, 15 W TDP Integrated Intel UHD 620 graphics

RAM/SSD SUPPORT

- 2x 260-pin SO-DIMM slot Supports up to 2x 32 GB DDR4-2400
- M.2-2280M slot supports one SSD card (PCIe X4 NVMe or SATA)

BACK PANEL CONNECTORS

■ HDMI 1.4 ■ 4x USB 3.2 Gen 1 ■ Dual Gigabit LAN ■ COM Port RS232 ■ Mic-in and Line-out ■ DC-input (2.5/5.5 mm) ■ Power Button

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Category	Product Name	Intel ULV Processor	AMT/vPRO Support	Operating- temp.	Operating System	RAM	M.2 SSD	Pre-installed I/O Expansion Kits	Bar Code
	BPCWL02-i3	Core i3-8145UE	-	040 °C	-	-	-	-	887993005003
Barebone	BPCWL02-i5	Core i5-8365UE	Yes	040 °C	-	-	-	-	887993005010
	BPCWL02-i7	Core i7-8665UE	Yes	040 °C	-	-	-	-	887993005607
System	BPCWL02-i3XA	Core i3-8145UE	-	040 °C	-	4 GB	120 GB	Dual COM, 4x USB 2.0, VGA, DC-in: 9-36V	4046047103652
Fix	BPCWL02-i5WA	Core i5-8365UE	Yes	040 °C	Win10 loT	8 GB	250 GB	Dual COM, 4x USB, VGA, DC-in: 9-36V	4046047103669
			e				/ 5		

System BTO Optionally choose an individual configuration for a complete system according to your wishes (Built-to-order)

[1] For the extended operating temperature range (-20 to +60°C) a special 150W power supply (Order No. PA1501) and industrial-grade RAM/SSD components with an operating temperature range of -40 ... +85 °C are required.

■ Hardware TPM v2.0 Infineon SLB9670VQ2 onboard

OPTIONAL FRONT PANEL CONNECTORS

- Graphics ports: HDMI 1.4, DVI-I, DisplayPort 1.2 or VGA
- Up to three additional COM ports
- Up to 8 (16) additional USB 2.0 ports
- Up to four additional 2.5 Gbps LAN ports

Up to four Digital I/O expansion kits (each with 4x Input and 4x Output) ■ Input for car ignition lock enables delayed on/off switching of the BoxPC

LTE/WLAN OPTIONS

■ LTE/4G kit with 2 antennas (LTE card and Nano-SIM not included) ■ WLAN kit with 2 antennas Wi-Fi 6 (ax)

POWER SUPPLY

- DC-Input: 19V, optional wide range DC-input 9~36V
- External 90W/19V power adapter

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Front and Back Panel



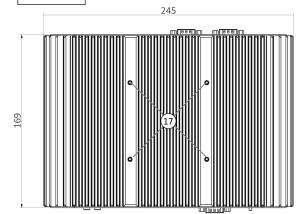
Inside View

Front Panel



Dimensions





Back Panel



1. The front panel has four sections to support optional I/O expansion kits

Example for optional I/O ports:



- 2. Audio Line Out (Headphones output)
- 3. Microphone input
- 4. Gigabit LAN port (Intel i211, black)
- 5. Gigabit LAN port (Intel i219LM, yellow)
- 6. 4x USB 3.2 Gen 1 Type A port
- 7. HDMI 1.4 port
- 8. COM port (RS232)
- 9. DC-in connector for power adapter
- 10. Power button
- 11. 2x WLAN antenna (optional)
- 12. Area for optional daughter boards
- 13. 2x SO-DIMM slot supports DDR4-2400
- 14. M.2-2280/2260 M slot for SSD card (NVMe/SATA)
- 15. Screw threads for VESA mount (75x75 mm)

The picture shows optional components (12, 13 and 14) that are not included in the barebone product.

Dimensions: Width: 245 mm (without optional ear mount) Depth: 169 mm Height: 57 mm (59 mm including feet)

Barebone models and optional accessories Caution: Only suitably trained persons may open the barebone and install optional components

The processor is permanently soldered onto the mainboard. The desired processor is selected with the barebone version:

	The processor is per		lesired processor is selected with the barebone version					
Processor	Shuttle BoxPC Barebone Modell	Built-in Processor	Cores	Threads	Takt / GHz	Cache	AMT/vPro	
110003301	BPCWL02-i3	Intel Core i3-8145UE	2	4	2.2 - 3.9	4 MB	_	
	BPCWL02-i5	Intel Core i5-8365UE	4	8	1.6 – 4.1	6 MB	Supported	
	BPCWL02-i7	Intel Core i7-8665UE	4	8	1.7 - 4.4	8 MB	Supported	
Storage	you purchase from a 1) up to 2x 32 GB	ponents into the barebor specialized dealer: DDR4 SO-DIMM (DDR4-24 SD card with PCIe/NVMe	SO-DIM	M DDR4	M.2-22	80 SSD Card		
Operating- temperature	The permissible oper components is 0 The extended tempe permissible with the 1) special 150W pr 2) industrial-grade temperature ra	40 0		-20 -)°C			
Mounting	The BoxPC can be pl be mounted in the fo Mounting Method VESA-mount, 75x75 Ear mount brackets Clip for DIN Rail mou See explanations on	Acce mm from spi (on both sides) inting	ubber feer ssory Proc ecialised c MRS01 MDR01	luct		IRSO1		MDR01
WLAN	Perforations provide mounting the WLAN Description 2x exteral antenna cable, 2x thermal pa M.2-2230 WLAN car	Acce 2x antenna ad	e BoxPC f ssory Proc CWL01 tincluded	luct	WLAN C		CW CW	/L01
Extended Voltage Range	The DC input connector (2.5 / 5.5 mm) supports 19V input voltage and a suitable 90W power adapter is included in the scope of delivery. To be able to use other power sources, the input voltage range can be extended to 9 36 V DC by adding the optional voltage regulator modul with order no. VOLO1 .			n the je range		R	Ì	VOLO1
Upgrade of a LAN port	The black LAN port on the back panel with max. 1 Gbps speed can optionally be upgraded to 2.5 Gbps speed (Intel i226 chip) with the accessory IDL11.						9330 HOMI U5830 © CONI 	DCIN POWER

Optional I/O Ports Front Panel

Expansion concept with optional daughter boards

The front panel is subdivided into four sections to support optional expansion kits in order to add I/O ports.

Every optional expansion kit is required to start from Section 1 (on the right) with the second kit occupying Section 2 etc. Some kits occupy two sections.



Expansion options:

PORT	ORDER No.	IMAGE	OCCUPIED Sections	MAXIMUM KITS	NOTE
HDMI 1.4 DP 1.2 DVI-I VGA	DHD01 DDP01 DDV01 DVG01		1	1	 1) One HDMI 1.4 port is in the back panel (fix). 2) One of these graphics ports can be added: HDMI 1.4, DisplayPort 1.2, DVI-I or VGA. 3) In addition, a VGA port can be installed, but this is not Plug&Play-capable.
4x USB 2.0	USB01	USB 2.0	1	2 (4)	USB hub device (USB 2.0 ports allow up to 500mA/2.5W power output, but if only low power devices like mouse/keyboard are connected, then up to 4 USB kits can be used)
Single COM	CRS01	¢ COM	1	1	Supports RS232 only (passive cable adapter)
Dual COM	CSD01		2	1	Supports RS232/RS422/RS485 (with additional I/O controller chip)
LTE/4G Kit with 2 antennas	LTE01	OFF ON B SIM1 SIM2	2	1	Not included: M.2 LTE/4G card and Nano SIM card Compatible with e.g. Huawei ME906S, Sierra EM7455, Quectel EM06E etc.
4x LAN ports with 2.5 Gbps	IDL01	LAN LAN LAN LAN	2	1	In addition to the existing 2x 1G LAN ports you can add four LAN ports with 2.5G speed <u>Note:</u> then only M.2 SSD cards with SATA interface are supported (no more PCIe/NVMe)
Dig. I/O-Kit 4x In / 4x Out	DI011	D0 4321G	1	4	up to four Digital I/O expansion kits each with 4x Input and 4x Output
Input for car ignition lock	DI001		1	1	Input for car ignition lock enables delayed on/off switching of the BoxPC
Port for external Power Button	PWR01	REMOTE SW	1	1	Screw terminals for a cable for an external power button

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Operating Positions and Mounting

	NOTE	IMAGE
Placed horizontally	The Shuttle Box-PC series BPCWL02 can be operated in horizontal position like a desktop PC standing on its rubber feet.	
VESA-mounted	The Shuttle Box-PC series BPCWL02 features four threaded M4 holes on the upper side for a standard 75 x 75 mm VESA mount, which allows for installation on to walls or large displays. The VESA mount is not included.	
Ear-mounted	The Shuttle Box-PC series BPCWL02 features four threaded M3 holes on the bottom, which allows for it to be attached to two Ear Mount brackets (optional accessory MRS01). The Box-PC can then be affixed to a surface with four M4 screws (mounting dimension: 256 mm x 100 mm).	
DIN-Rail-mounted	The Shuttle Box-PC series BPCWL02 features two threaded M3 holes on the bottom, which allows for installation on a standard 35 mm DIN-Rail, e.g. inside equipment racks. The matching DIN-Rail clip is an optional accessory (MDR01).	47.5 mm

SHUTTLE Box-PC Barebone BPCWL02-i3 — SPECIFICATIONS Caution: Only suitably trained persons may open the barebone and install optional components!

FANLESS AND SILENT	Equipped with passive cooling, no fan noise at all Perfect to be used in noise-sensitive environments Fanless, dust-free and thus virtually maintenance-free						
24/7 NONSTOP Operation	This device is approved for 24/7 permanent operation. Requirement: Free circulation of air amongst the PC must be guaranteed.						
CHASSIS	Durable and rugged chassis made of aluminium and steel. Passive cooling system with specially designed fins to maximize heat dissipation. Dimensions: 16,9 x 24,5 x 5,7 cm (LWH) = approx. 2,7 litres Weight: 2.85 kg net (Barebone without RAM/SSD and optional expansions) IP-rating: IP30						
OPERATING POSITIONS AND MOUNTING	 <u>1) Desktop:</u> The unit can be placed horizontally to stand on its feet. <u>2) VESA Mount:</u> The unit can be affixed to a 75 mm x 75 mm VESA bracket. For this purpose, four M4x6L screws are required to be screwed into the chassis from the top. <u>3) Side Brackets (MRS01)</u>: The unit can be mounted using two optional 256 mm x 100 mm ear-mount brackets. For this purpose, four M3x6L screws are required to be screwed into the chassis from the bottom. <u>4) DIN-Rail (MDR01)</u>: Mounted on a standard 35 mm DIN-Rail, e.g. inside equipment racks Notes: VESA bracket, Ear-Mount and DIN-Rail clip are not included. Vertical mounting is permitted in any orientation. 						
OPERATING SYSTEM	This system is compatible with Windows 10/11 (64-bit) and Linux (64-bit).						
PROCESSOR	Shuttle BoxPC Barebone ModelBuilt-in ProcessorCores/ ThreadsCacheClock frequency (Turbo)vPro SupportIntel UHD GraphicsBPCWL02-i3Intel Core i3-8145UE2 / 44 MB2.2-3.9 GHz-UHD 620, 300-1000 MHzBPCWL02-i5Intel Core i5-8365UE4 / 86 MB1.6-4.1 GHzYesUHD 620, 300-1050 MHzBPCWL02-i7Intel Core i7-8665UE4 / 88 MB1.7-4.4 GHzYesUHD 620, 300-1150 MHzSystem-on-a-chip architecture (SoC) with integrated memory and graphics controllerFCBGA1528 package - directly soldered onto the mainboardCode name: Whiskey Lake-U (8th Generation Intel Core), Manufacturing process: 3rd-generation enhanced 14nm++TDP wattage: 15 W maximum15 WMaximum						
INTEGRATED GRAPHICS	Intel UHD Graphics 620 GPU clock frequency: 300~1000 MHz Execution Units (EUs): 24 Supports up to three independent screens: 1) HDMI 1.4 on the backpanel 2) optional HDMI 1.4, DisplayPort 1.2, DVI-I or D-Sub/VGA (DDI interface) 3) optional D-Sub/VGA (eDP interface, limitations: no PnP support)						
UEFI BIOS	Supports resume after power failure Supports Wake on LAN (WOL) Supports Power on by RTC Alarm Supports boot from M.2 SSD cards and USB devices AMI BIOS in 16 or 32 MB EEPROM with SPI interface Supports hardware monitoring and Watchdog function Supports Unified Extensible Firmware Interface (UEFI)						
INTEL vPRO/AMT (optional)	Supports Intel® vPro™ and AMT – only in connection with Intel Core i5-8365UE or Intel Core i7-8665UE processors Intel® vPro™ is a brand name for a specific set of management and security technologies. Intel® Active Management Technology (AMT) is a subset of Intel vPro. This technology allows remote management of PCs, even in power-off mode or with non-functional operating systems. You can audit, repair and restore AMT-based platforms in a LAN. These functions can increase the uptime of desktops with lower maintenance costs. <u>Note:</u> Intel vPro requires appropriate software. The Intel® MEBX configuration user interface can be accessed after pressing CTRL-P at the beginning of the boot process. Only the Intel i219 LAN port (yellow color) supports the Intel vPro® function.						
TPM MODULE	Hardware Trusted Platform Module (Infineon SLB9670VQ2 TPM 2.0)						

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	Power Adapter	Operating Temperature	Output Wattage	AC Input	DC Output	AC Cable			
	Supplied model	0 to +40°C	Max. 90 W	100-240V, 50/60Hz	19V, max. 4.74A	Schuko to IEC 60320 C5			
POWER ADAPTER [1]	PA1501 (optional)	-20 to +60°C	Max. 150 W (95W at 60°C)	90-260V, 50/60Hz	19V, max. 7.89A	Schuko to IEC 60320 C13			
	DC Connector: 5.5/2.5 mm (outer/inner diameter) AC mains cable: 3 pins, ca. 1.8 m length, with C5/C6 coupler (called "Mickey Mouse" or "Clover-leaf") for the power adapter and CEE-7/7 plug with earth-contact (type E+F) for the power outlet Note: The DC input voltage range can optionally be extended to support 9-36 V.								
MEMORY SUPPORT [1]	2x SO-DIMM slot with 260 pins Supports DDR4-2400 (PC4-19200) SDRAM at 1.2 V Supports Dual Channel mode Supports a maximum of 32 GB per DIMM, maximum total size: 64 GB Supports two unbuffered DIMM modules (no ECC or registered)								
M.2 SLOT FOR SSDs [1]	The M.2 2280 M slot provides the following interfaces: - PCI-Express Gen. 3.0 X4 - SATA v3.0 (max. 6 Gbps) It supports M.2 cards with a width of 22 mm and a length of 60 or 80 mm (type 2260, 2280). Supports M.2 SATA SSDs (with B+M key) and M.2 PCIe NVMe SSDs (with M key) with auto detect								
AUDIO	Audio Realtek® ALC662 or ALC888S High-Definition Audio Two analog audio connectors (3.5 mm) on the back panel: 1) 2 channel line out (headphones) 2) microphone input Digital multi-channel audio output: via HDMI and optional DisplayPort								
DUAL GIGABIT LAN	Dual network with two RJ45 ports Used network chips: 1) Intel i211 Ethernet Controller with MAC, PHY and PCIe interface [3] 2) Intel i219LM PHY connected to the MAC of the processor Supports 10 / 100 / 1000 MBit/s operation Supports WAKE ON LAN (WOL) Supports network boot by Preboot eXecution Environment (PXE)								
BACK PANEL Connectors	2x Intel Gigab Serial COM po Microphone ir Audio Line-ou	en 1 Type A (max. 5 G it LAN (RJ45, i211/i2 rt (RS232)	19LM) [3] mm)	/ 5.5 mm)					
OPTIONAL FRONT Panel connectors	ports. Cautior 1) second gra 2) third graph 3) one COM pr 4) two COM p 5) 4x USB 2.0 devices like m 6) 4x LAN por 7) up to four E 8) Input for ca 9) LTE kit with EM7455, Quee	a: Only suitably train obics port: HDMI 1.4 ics port: D-Sub/VGA ort RS232 (CRS01) orts RS232/RS422/ - can be installed tw nouse/keyboard are ts with 2.5 Gbps train ligital I/O expansion ar ignition lock enable two external Anten ctel EMO6E) and Nan	ed persons may op (DHDO1), DisplayPer RS485 - occupies rice (Note: USB 2.0 connected, then u hsfer speed (IDLO1 kits, each with 4x es delayed on/off nas (LTEO1). Not ir o-SIM card.	two sections (CSD01)) ports allow up to 500r p to 4 USB kits can be u) Input and 4x Output (DI switching of the BoxPC	stall optional com DV01) or D-Sub/V0 mA/2.5W power of Ised) (USB01) 011) [2] (DI011) -3042 format (e.g				
FURTHER OPTIONAL Accessories	2) Ear-mount 3) DIN-Rail cli 4) WLAN mod	p (special clip has ho ule with two externa	dimensions: 256 r Iles without thread I antennas (WMA)	nm x 100 mm (MRS01) d) (MDR01)					

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	Option	Operating temperature	Relative humidity	
ENVIRONMENTAL	Standard	0 to +40°C	20-80 %, non-condensing	
SPECIFICATIONS	Industrial	-20 to +60°C	20-80 %, non-condensing	
	Notice the foo	tnote [1]		
CONFORMITY AND CERTIFICATIONS	Safety: CB, cT Other: RoHS, I This device is industrial area (1) 2014/30/E (2) 2014/35/E	rP, CEC classed as a technical info is. The CE-mark approves U relating to electromagn U relating to Electrical Eq	the conformity by the EU directive	certain voltage limits (LVD),

[1] for safe operation in the extended operating temperature range (-20 to +60°C), the optional 150W power supply PA1501 is required and industrial-grade RAM/SSD components with an operating temperature range of -40 ... +85 °C are also required
[2] The DIO expansion kit comes with the appropriate plug connector included. The digital inputs recognize "Low" at 0-3 Volt and "High" at 5-30 Volt (or open). The digital outputs can handle 0-30V (open collector) with up to 30 mA current.
[3] LAN-Port-Upgrade

The yellow LAN port on the back panel (Intel i211 chip) with max. 1 Gbps speed can optionally be upgraded to 2.5 Gbps speed (Intel i226 chip) with the accessory IDL11.